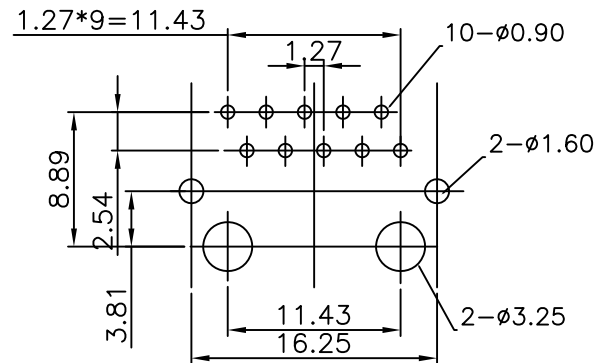
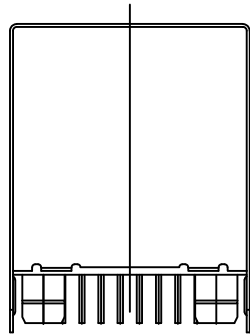
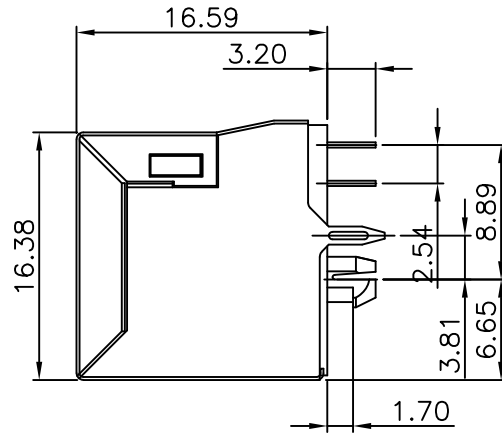
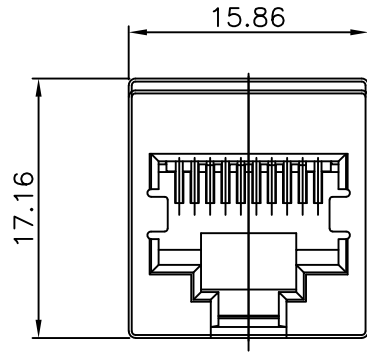


RoHS compliant



PCB LAYOUT/TOP VIEW

NOTES

MATERIAL

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE T=0.35mm.
3. PLATING : CONTACT AREA-SELECTIVE GOLD
TAILS PLATING TIN OVER NICKEL.
: 3U", 6U", 15U", 30", 50".

ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C ~ +85°C.
2. OPERATION : -40°C ~ +85°C.

P/N: RJ52D-1111-132XXXX

GOLD PLATING	PLASTIC	COLOR	NOTE
1-Gold Flash	1-PBT	1-BLACK	X=NO Note
2-1u	2-NYLON66	2-WHITE	
3-1.5u	3-NYLON46	3-RED	
4-3u		4-YELLOW	
5-6u			

					GENERAL TOLERANCE		DRAWN		Gene Li		2017/03/14		X-SHUN 东莞市祥舜电子科技有限公司			
					.X	±0.35	X.°	± 2°	CHECKE		JH		DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD			
					.XX	±0.25	.X.°	± 1°	APPROVE				PART NO.	RJ52D-1111-132511X		
					.XXX	±0.15	.XX.°	± 0.5°					TITLE:	RJ50 10P10C 180° W/SHIELD B3. 81		
REV	ECN NO	DESCRIPTION	DATE	SIGNATURE	PROJECT		UNIT	mm	SCALE	1:1	SHEET	1/1	REV	A0	DRAWING NO.	RJ52D-04